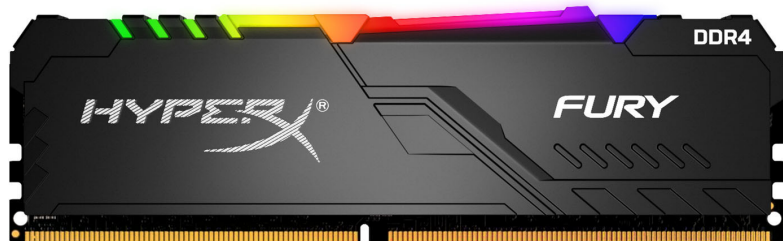


HX434C17FB3AK2/64

64GB (32GB 4G x 64-Bit x 2 pcs.)
 DDR4-3466 CL17 288-Pin DIMM Kit



SPECIFICATIONS

CL(IDD)	17 cycles
Row Cycle Time (tRCmin)	45.75ns(min.)
Refresh to Active/Refresh Command Time (tRFCmin)	350ns(min.)
Row Active Time (tRASmin)	32ns(min.)
UL Rating	94 V - 0
Operating Temperature	0° C to +70° C
Storage Temperature	-40° C to +85° C

DESCRIPTION

HyperX HX434C17FB3AK2/64 is a kit of two 4G x 64-bit (32GB) DDR4-3466 CL17 SDRAM (Synchronous DRAM) 2Rx8, memory module, based on sixteen 2G x 8-bit FBGA components per module. Each module kit supports Intel® Extreme Memory Profiles (Intel® XMP) 2.0. Total kit capacity is 64GB. Each module has been tested to run at DDR4-3466 at a low latency timing of 17-21-21 at 1.35V. The SPDs are programmed to JEDEC standard latency DDR4-2400 timing of 17-17-17 at 1.2V. Each 288-pin DIMM uses gold contact fingers. The JEDEC standard electrical and mechanical specifications are as follows:

FEATURES

- Power Supply: VDD = 1.2V Typical
- VDDQ = 1.2V Typical
- VPP = 2.5V Typical
- VDDSPD = 2.2V to 3.6V
- On-Die termination (ODT)
- 16 internal banks; 4 groups of 4 banks each
- Bi-Directional Differential Data Strobe
- 8 bit pre-fetch
- Burst Length (BL) switch on-the-fly BL8 or BC4(Burst Chop)
- Height 1.624" (41.24mm), w/heatsink

FACTORY TIMING PARAMETERS

- Default (JEDEC): DDR4-2400 CL17-17-17 @1.2V
- XMP Profile #1: DDR4-3466 CL17-21-21 @1.35V
- XMP Profile #2: DDR4-3000 CL16-18-18 @1.35V

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